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About Cypress

Cypress (NASDAQ: CY) delivers high-performance, high-quality solutions at the heart of today's most advanced embedded systems, from automotive, industrial and networking platforms to highly interactive consumer and mobile devices. With a broad, differentiated product portfolio that includes NOR flash memories, F-RAM™ and SRAM, Traveo™ microcontrollers, the industry's only PSoC® programmable system-on-chip solutions, analog and PMIC Power Management ICs, CapSense® capacitive touch-sensing controllers, and Wireless BLE Bluetooth® Low-Energy and USB connectivity solutions, Cypress is committed to providing its customers worldwide with consistent innovation, best-in-class support and exceptional system value.

ASSP

BIPOLAR

VOLTAGE DETECTOR

MB3761

■ DESCRIPTION

Designed for voltage detector applications, the Fujitsu Microelectronics MB3761 is a dual comparator with a built-in high precision reference voltage generator. Outputs are open-collector outputs and enable use of the OR-connection between both channels. Both channels have hysteresis control outputs. Because of a wide power supply voltage range and a low power supply current, the MB3761 is suitable for power supply monitors and battery backup systems.

■ FEATURES

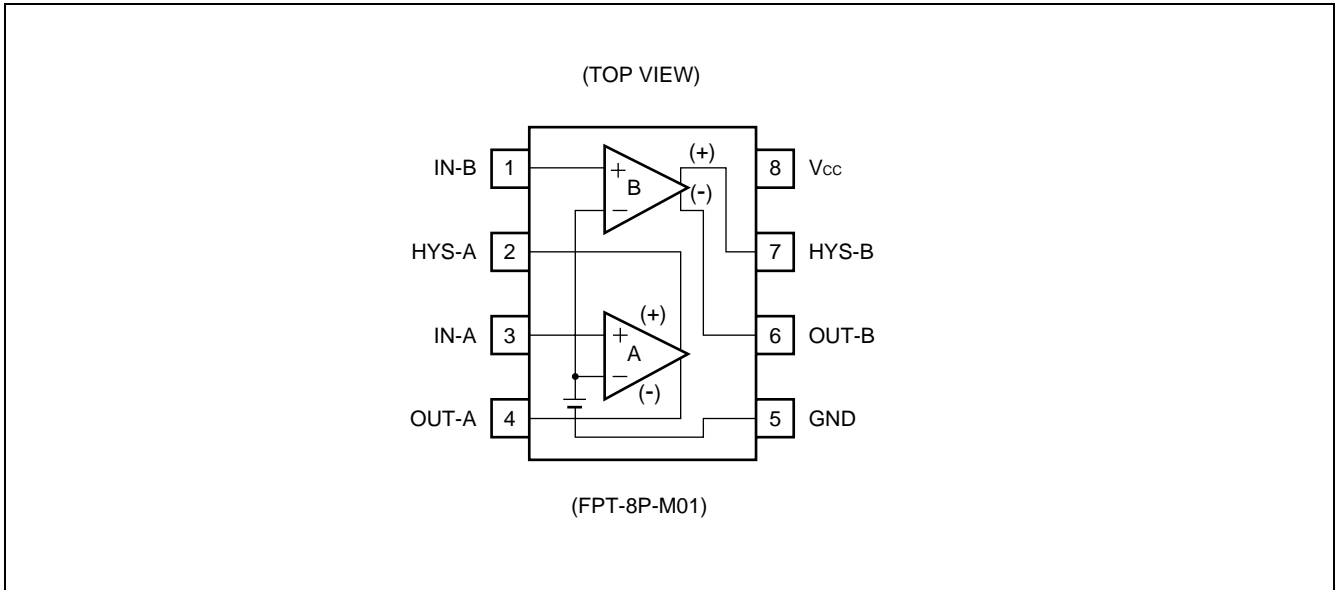
- Wide power supply voltage range: 2.5 V to 40 V
- Low power and small voltage dependency supply current: 250 μ A Typ
- Built-in stable low voltage generator: 1.20 V Typ
- Easy-to-add hysteresis characteristics.
- One type of package (SOP-8pin : 1 type)

■ APPLICATIONS

- Industrial Equipment
- Arcade Amusement etc.

MB3761

■ PIN ASSIGNMENT



■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating		Unit
		Min	Max	
Power Supply Voltage	V _{CC}	—	41	V
Output Voltage	V _O	—	41	V
Output Current	I _O	—	50	mA
Input Voltage	V _{IN}	− 0.3	+ 6.5	V
Power Dissipation	P _D	—	350 (T _A ≤ +70°C)	mW
Storage Temperature	T _{STG}	− 55	+ 125	°C

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Value		Unit
		Min	Max	
Power Supply Voltage	V _{CC}	2.5	40	V
Operating Ambient Temperature	T _A	− 20	+ 75	°C
Output Current at pin 4	I _{O4}	—	4.5	mA
Output Current at pin 6	I _{O6}	—	3.0	mA

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

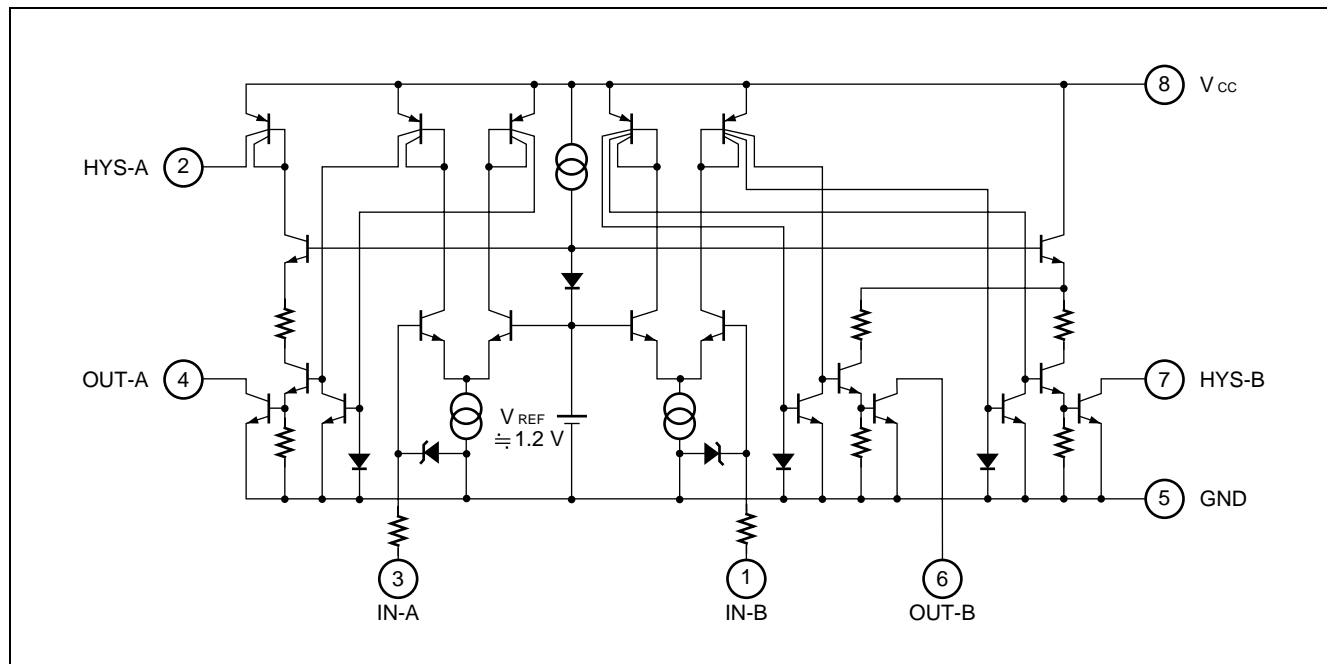
MB3761

■ ELECTRICAL CHARACTERISTICS

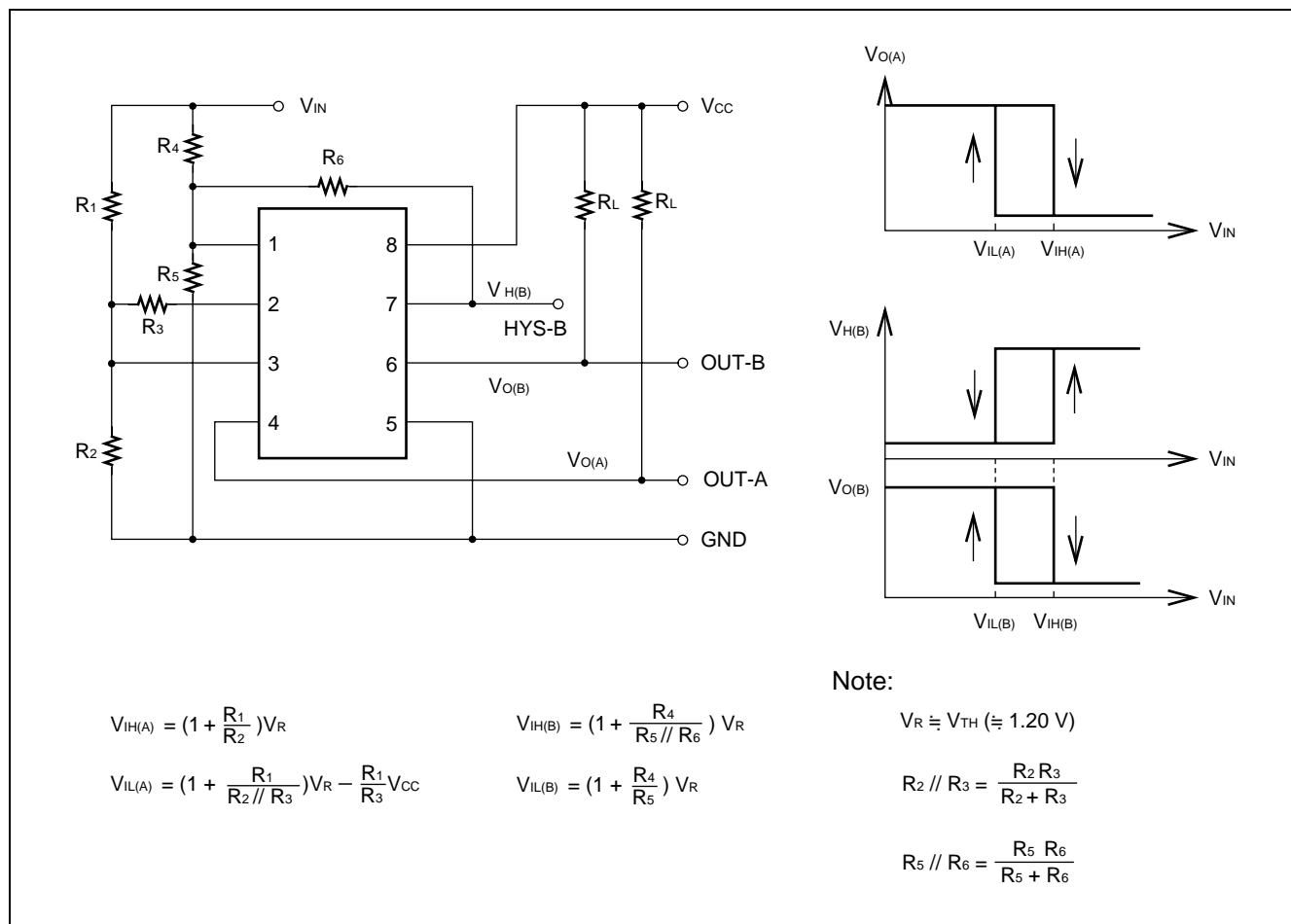
($T_A=+25^{\circ}\text{C}$, $V_{CC}=5\text{ V}$)

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
Power Supply Voltage	ICCL	$V_{CC}=40\text{ V}$, $V_{IL}=1.0\text{ V}$	-	250	400	μA
	ICCH	$V_{CC}=40\text{ V}$, $V_{IH}=1.5\text{ V}$	-	400	600	μA
Threshold Voltage	V_{TH}	$I_O=2\text{ mA}$, $V_O=1\text{ V}$	1.15	1.20	1.25	V
Deviation of Threshold Voltage	ΔV_{TH1}	$2.5\text{ V} \leq V_{CC} \leq 5.5\text{ V}$	-	3	12	mV
	ΔV_{TH2}	$4.5\text{ V} \leq V_{CC} \leq 40\text{ V}$	-	10	40	mV
Offset Voltage between Outputs	V_{OOSA}	$I_{OA}=4.5\text{ mA}$, $V_{OA}=2\text{ V}$, $I_{HA}=20\text{ }\mu\text{A}$, $V_{HA}=3\text{ V}$	-	2.0	-	mV
	V_{OSSB}	$I_{OB}=3\text{ mA}$, $V_{OB}=2\text{ V}$, $I_{HB}=3\text{ mA}$, $V_{HB}=2\text{ V}$	-	2.0	-	mV
Temperature Coefficient of Threshold Voltage	α	$-20^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$	-	± 0.05	-	$\text{mV}/^{\circ}\text{C}$
Difference Voltage on Threshold Voltage between Channel	ΔV_{THAB}	-	-10	-	+10	mV
Input Current	I_{IL}	$V_{IL}=1.0\text{ V}$	-	5		nA
	I_{IH}	$V_{IH}=1.5\text{ V}$	-	100	500	nA
Output Leakage Current	I_{OH}	$V_O=40\text{ V}$, $V_{IL}=1.0\text{ V}$	-	-	1	μA
Hysteresis Output Leakage Current	I_{HLA}	$V_{CC}=40\text{ V}$, $V_{HA}=0\text{ V}$, $V_{IL}=1.0\text{ V}$	-	-	0.1	μA
	I_{HHB}	$V_{HB}=40\text{ V}$, $V_{IH}=1.5\text{ V}$	-	-	1	μA
Output Sink Current	I_{OLA}	$V_O=1.0\text{ V}$, $V_{IH}=1.5\text{ V}$	6	12	-	mA
	I_{OLB}	$V_O=1.0\text{ V}$, $V_{IH}=1.5\text{ V}$	4	10	-	mA
Hysteresis Current	I_{HHA}	$V_H=0\text{ V}$, $V_{IH}=1.5\text{ V}$	40	80	-	μA
	I_{HLB}	$V_H=1.0\text{ V}$, $V_{IL}=1.0\text{ V}$	4	10	-	mA
Output Saturation Voltage	V_{OLA}	$I_O=4.5\text{ mA}$, $V_{IH}=1.5\text{ V}$	-	120	400	mV
	V_{OLB}	$I_O=3.0\text{ mA}$, $V_{IH}=1.5\text{ V}$	-	120	400	mV
Hysteresis Saturation	V_{HHA}	$I_H=20\text{ }\mu\text{A}$, $V_{IH}=1.5\text{ V}$	-	50	200	mV
	V_{HLB}	$I_H=3.0\text{ mA}$, $V_{IL}=1.0\text{ V}$	-	120	400	mV
Output Delay Time	t_{PHL}	$R_L=5\text{ k}\Omega$	-	2	-	μs
	t_{PLH}	$R_L=5\text{ k}\Omega$	-	3	-	μs

■ EQUIVALENT CIRCUIT

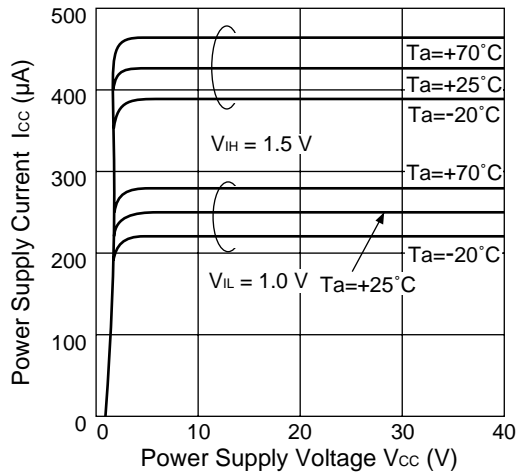


■ OPERATIONAL DEFINITIONS

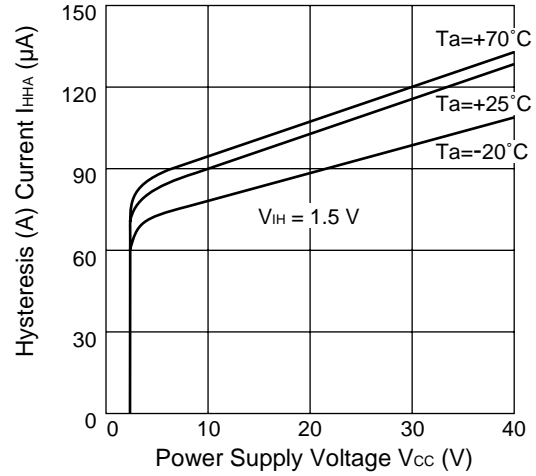


TYPICAL PERFORMANCE CHARACTERISTICS

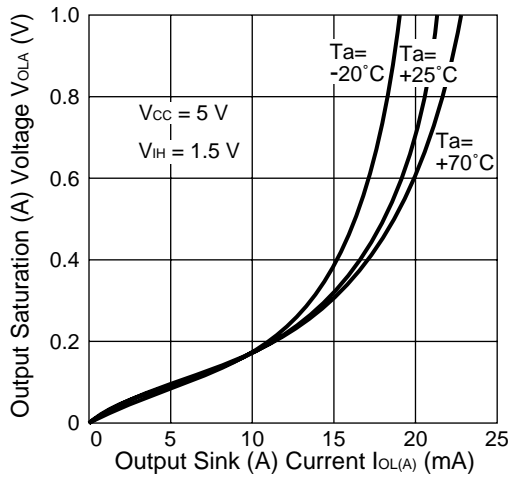
Power Supply Current vs. Power Supply Voltage



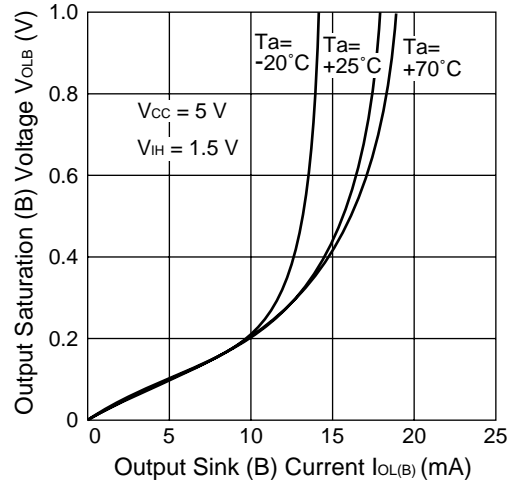
Hysteresis (A) Current vs. Power Supply Voltage



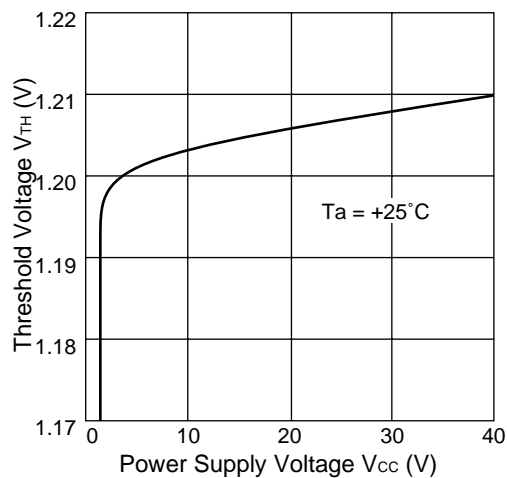
Output Saturation (A) Voltage vs. Output Sink (A) Current



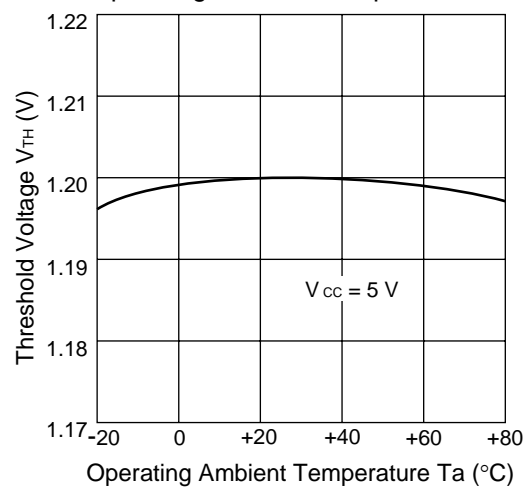
Output Saturation (B) Voltage vs. Output Sink (B) Current



Threshold Voltage vs. Power Supply Voltage

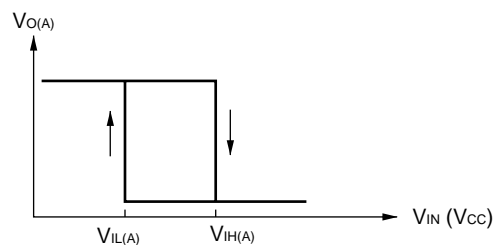
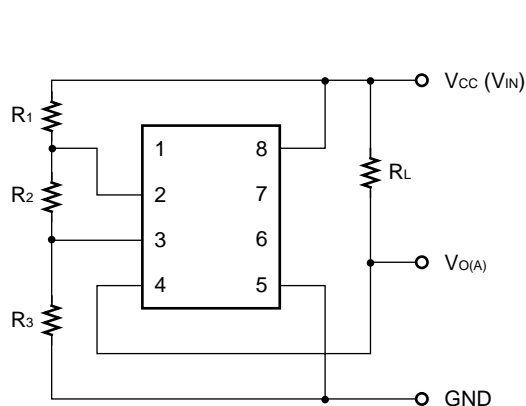


Threshold Voltage vs. Operating Ambient Temperature



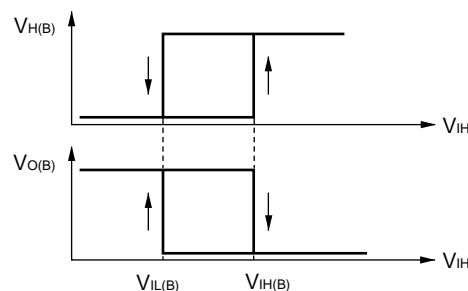
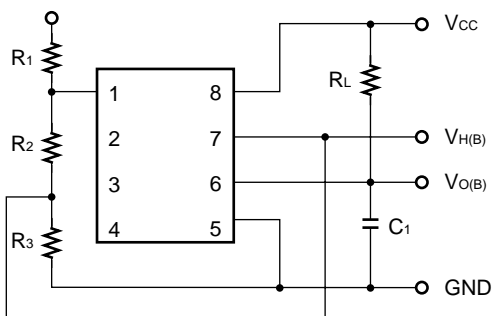
APPLICATION EXAMPLES

1. Addition of Hysteresis



$$V_{IH(A)} \cong \left(1 + \frac{R_1 + R_2}{R_3}\right) V_R$$

$$V_{IL(A)} \cong \left(1 + \frac{R_2}{R_3}\right) V_R$$

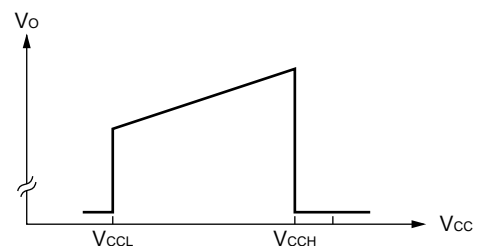
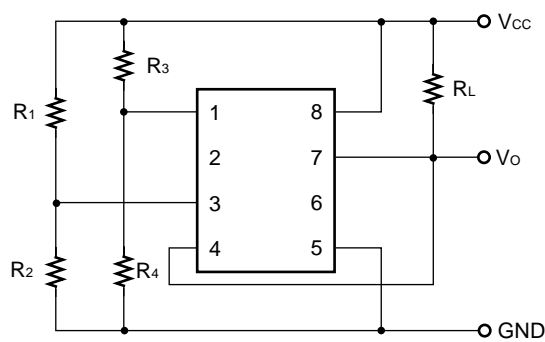


$$V_{IH(B)} \cong \left(1 + \frac{R_1}{R_2}\right) V_R$$

$$V_{IL(B)} \cong \left(1 + \frac{R_1}{R_2 + R_3}\right) V_R$$

Note : All calculations occur with the output voltage at 0. The hysteresis values are adjusted for load condition and saturation voltage.

2. Voltage Detection for Alarm



$$V_{CCH} = \left(1 + \frac{R_1}{R_2}\right) V_R$$

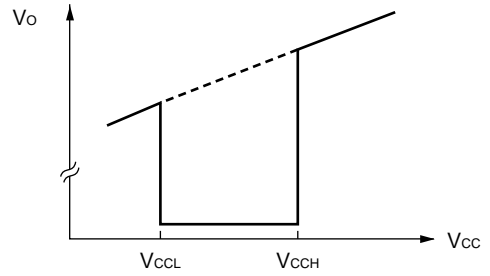
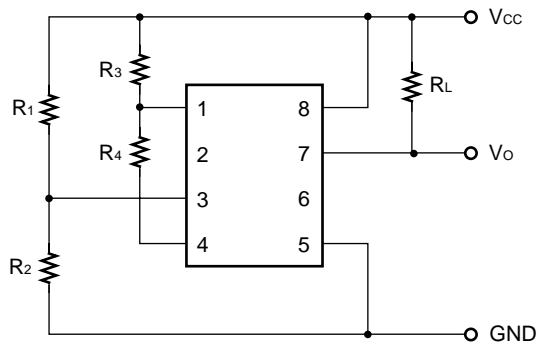
$$V_{CCL} = \left(1 + \frac{R_3}{R_4}\right) V_R$$

$$V_{CCL} \geq 2.5 \text{ V}$$

For hysteresis, a positive feedback from pin 2 or 7 is required.

MB3761

3. Voltage Detection for Alarm

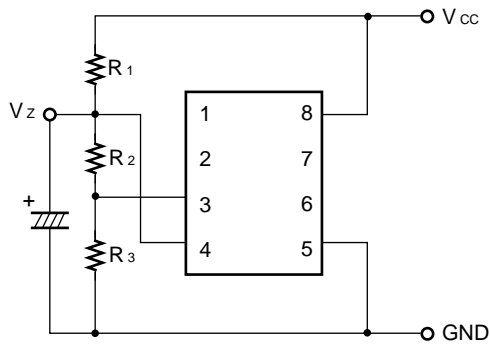


$$V_{CCH} = \left(1 + \frac{R_3}{R_4}\right) V_R$$

$$V_{CCL} = \left(1 + \frac{R_1}{R_2}\right) V_R$$

$$V_{CCL} \geq 2.5 \text{ V}$$

4. Programmable Zener

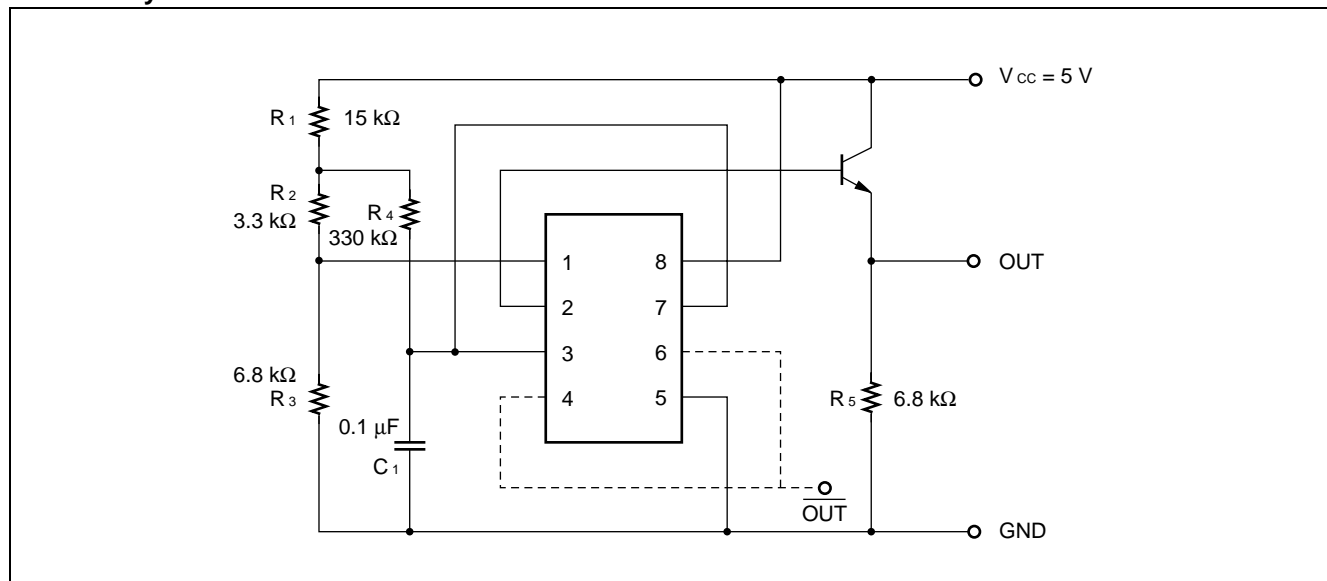


$$V_Z = \left(1 + \frac{R_2}{R_3}\right) V_R$$

$$\frac{V_Z}{R_2 + R_3} \leq \frac{V_{CC} - V_Z}{R_1} \leq 6 \text{ mA}$$

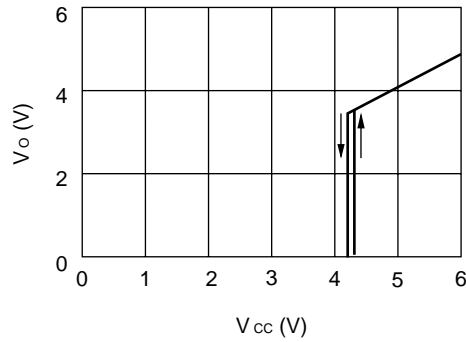
Note : Channel B can be used independently.

5. Recovery Reset Circuit

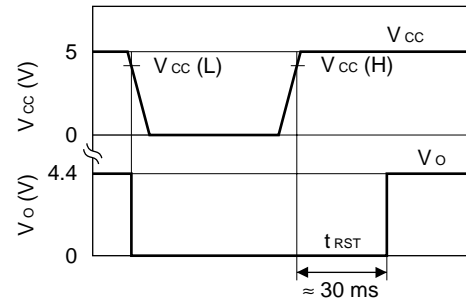


■ TYPICAL CHARACTERISTICS

DC Characteristics



Response Characteristics



- Voltage Threshold Levels ($V_{CC(L)}$ and $V_{CC(H)}$) and Hysteresis Width can be changed by the resistors (R_1 through R_4).

$$V_{CC(L)} = \frac{R_1 + R_2 + R_3}{R_3} V_{TH}$$

$$V_{CC(H)} = V_{CC(L)} + \frac{R_1 (R_2 + R_3)}{R_3 R_4} V_{TH}$$

- Power-On Reset Time is provided by the following approximate equation:

$$t_{RST} = -C_1 R_4 \cdot \ln \left\{ 1 - \frac{V_{TH}}{V_{CC}} \left(1 + \frac{R_1}{R_2 + R_3} \right) \right\}$$

- The recommended value of h_{FE} of the external transistor is from 50 to 200.
- In the case of an instant power fail, the remaining charge in C_1 effects t_{RST} .
- If necessary, the reversed output is provided on HYS terminal

■ NOTES ON USE

- Take account of common impedance when designing the earth line on a printed wiring board.
- Take measures against static electricity.
 - For semiconductors, use antistatic or conductive containers.
 - When storing or carrying a printed circuit board after chip mounting, put it in a conductive bag or container.
 - The work table, tools and measuring instruments must be grounded.
 - The worker must put on a grounding device containing 250 kΩ to 1 MΩ resistors in series.
- Do not apply a negative voltage
 - Applying a negative voltage of -0.3 V or less to an LSI may generate a parasitic transistor, resulting in malfunction.

■ ORDERING INFORMATION

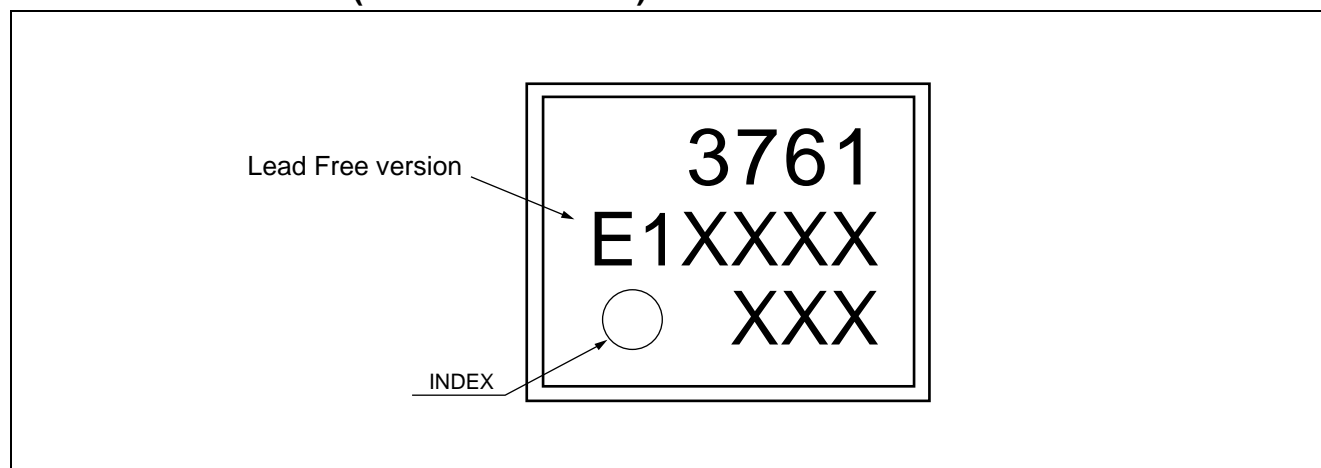
Part number	Package	Remarks
MB3761PF-□□□	8-pin plastic SOP (FPT-8P-M01)	Conventional version
MB3761PF-□□□E1	8-pin plastic SOP (FPT-8P-M01)	Lead Free version

■ RoHS Compliance Information of Lead (Pb) Free version

The LSI products of Fujitsu Microelectronics with “E1” are compliant with RoHS Directive , and has observed the standard of lead, cadmium, mercury, Hexavalent chromium, polybrominated biphenyls (PBB) , and polybrominated diphenyl ethers (PBDE) .

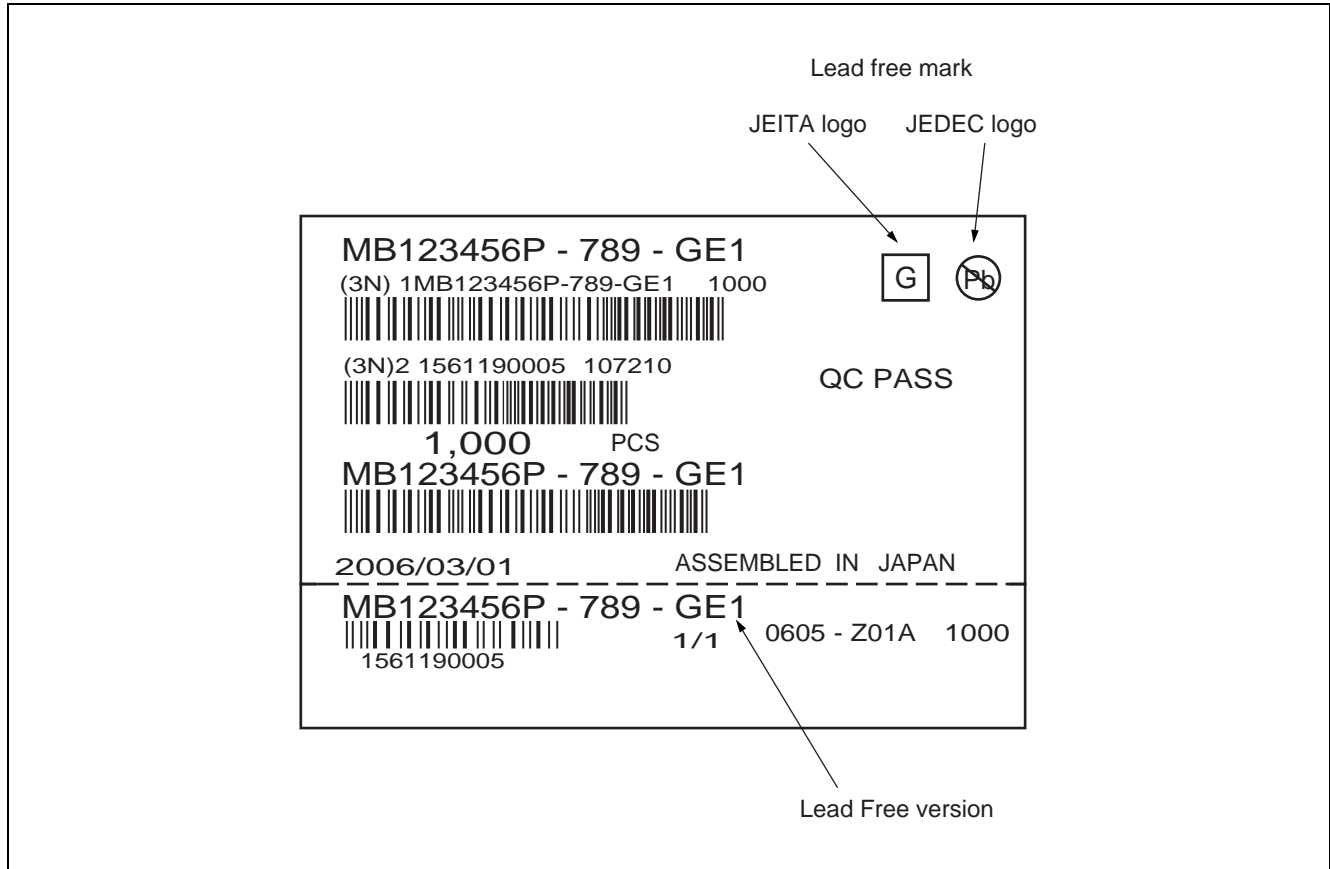
The product that conforms to this standard is added “E1” at the end of the part number.

■ MARKING FORMAT (Lead Free version)



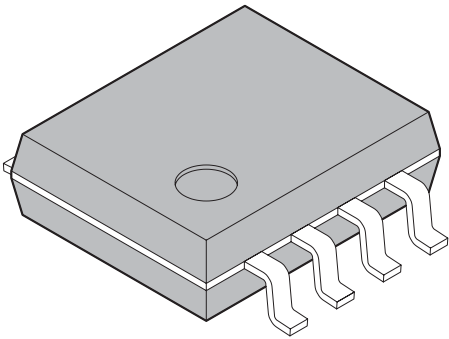
MB3761

■ LABELING SAMPLE (Lead free version)

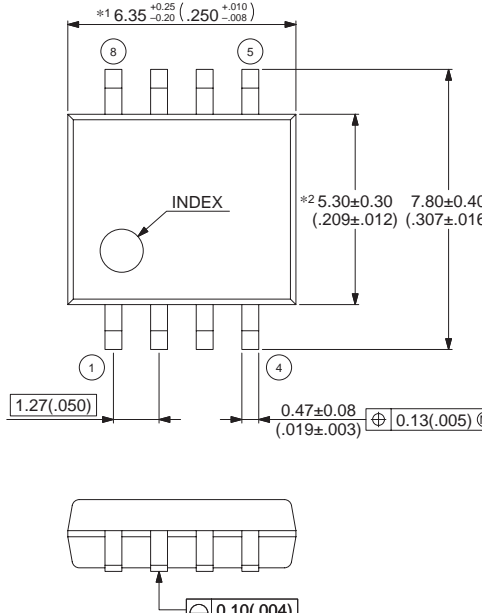


MB3761

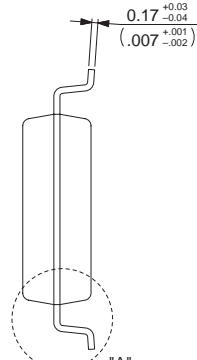
PACKAGE DIMENSION

<p style="text-align: center;">8-pin plastic SOP</p>  <p style="text-align: center;">(FPT-8P-M01)</p>	Lead pitch	1.27 mm
	Package width × package length	5.3 × 6.35 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	2.25 mm MAX
	Weight	0.10 g
	Code (Reference)	P-SOP8-5.3×6.35-1.27

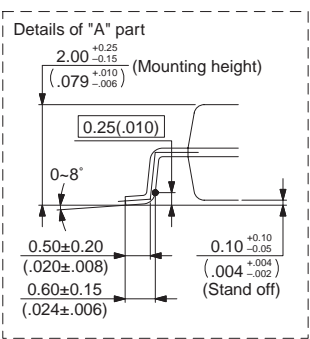
8-pin plastic SOP
(FPT-8P-M01)



Note 1) *1 : These dimensions include resin protrusion.
 Note 2) *2 : These dimensions do not include resin protrusion.
 Note 3) Pins width and pins thickness include plating thickness.
 Note 4) Pins width do not include tie bar cutting remainder.



Details of "A" part



Dimensions in mm (inches).
 Note: The values in parentheses are reference values.

MEMO

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Any semiconductor devices have an inherent chance of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

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